

Exploded view diagram of a 12-layer printed circuit board assembly. The components are numbered 1 through 12:

- 1: Top metal layer
- 2: Small metal pad
- 3: Vertical metal pin
- 4: Dielectric prepreg layer
- 5: Copper foil layer
- 6: Copper foil layer
- 7: Bottom metal layer
- 8: O-ring
- 9: Small metal pad
- 10: Spring
- 11: Small metal pad
- 12: Small metal pad



Drawing No.

PSF-0810200T